



materials



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Nano and Advanced Material Engineering

Guest Editor:

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Message from the Guest Editor

Dear Colleagues,

Nano and advanced material engineering encompasses novel findings and new perspectives related to the synthesis, self-assembly, fabrication, microstructure, properties, performance, and technological applications of advanced nanomaterials, as well as the photocatalysis, electrocatalysis, energy conversion and storage materials. As an important aspect of material engineering and nanotechnology, recent advances in nano-interface reaction properties, modulated mechanisms, environment sensing and targeting applications, biological, and medical uses are also welcomed.

Prof. Dr. Gongke Wang
Guest Editor



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Message from the Editor-in-Chief

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